High Performance ASIC Cooling Solutions w/Thermal Tape Attachment*

DIGI-KEY PART # ATS1351-ND

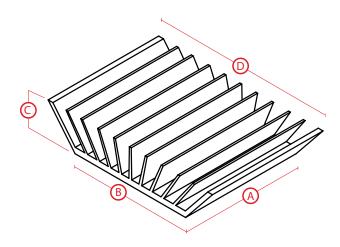
ATS PART # ATS-56006-C4-R0

Features & Benefits

maxiFLOW[™] design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling

Designed specifically for ASIC package and their unique cooling requirements

Thermal Performance Table





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AIR	VELOCITY	THERMAL RESISTANCE		
FT/MIN	M/S	°C/W (UNDUCTED)	°C/W (DUCTED)	
200	1.0	3.9	1.7	
300	1.5	3.1		
400	2.0	2.3		
500	2.5	2		
600	3.0	1.7		
700	3.5	1.5		
800	4.0	1.4		
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Product Details[†]

DIMENSION A	DIMENSION B	DIMENSION C [§]	DIMENSION D	TIM⁺	FINISH
50	45	12	59.2	NO TIM	BLACK-ANODIZED

For further technical information, please contact Advanced Thermal Solutions, Inc. at **1-781-769-2800** or **www.qats.com**

* RoHS Compliant

‡ TIM = Thermal Interface Material

† Dimensions are measured in millimeters

Dimension C = the height of the heat sink shown above

and does not include the height of the attachment method



